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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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# 2SB861

# Silicon PNP Triple Diffused

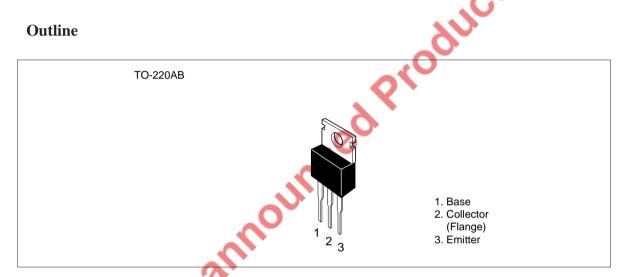


ADE-208-862 (Z) 1st. Edition September 2000

### **Application**

Low frequency power amplifier color TV vertical deflection output complementary pair with 2SD1138

#### **Outline**



### **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Rating	Unit
Collector to base voltage	V <sub>CBO</sub>	-200	V
Collector to emitter voltage	V <sub>CEO</sub>	-150	V
Emitter to base voltage	$V_{EBO}$	-6	V
Collector current	I <sub>c</sub>	-2	A
Collector peak current	I <sub>C(peak)</sub>	<b>-</b> 5	A
Collector power dissipation	P <sub>c</sub>	1.8	W
	P <sub>c</sub> *1	30	W
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-45 to +150	°C

1. Value at T<sub>C</sub> = 25°C Note:

### 2SB861

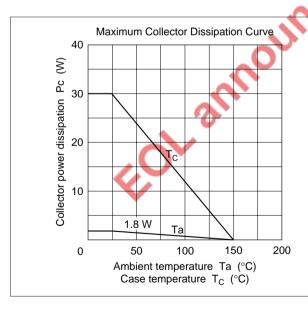
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

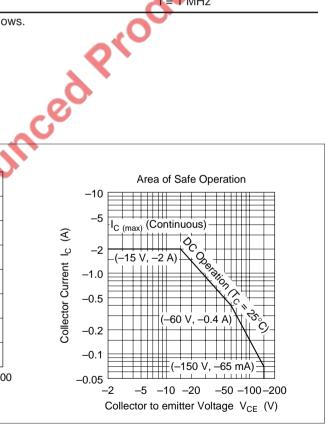
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CBO}$	-150	_	_	V	$I_{\rm C} = -50$ mA, $R_{\rm BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-6	_	_	V	$I_E = -5 \text{ mA}, I_C = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	-1	μΑ	$V_{CB} = -120 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE1</sub> *1	60	_	200		$V_{CE} = -4 \text{ V}, I_{C} = -50 \text{ mA}$
	h <sub>FE2</sub>	60	_	_		$V_{CE} = -10 \text{ V}, I_{C} = -500 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-3	V	$I_{\rm C} = -500 \text{ mA}, I_{\rm B} = -50 \text{ mA}$
Base to emitter voltage	$V_{\text{BE}}$	_	_	-1	V	$V_{CE} = -4 \text{ V, } I_{C} = -50 \text{ mA}$
Collector output capacitance	Cob	_	30	_	pF	$V_{CB} = -100 \text{ V}, I_{E} = 0,$ f = 1 MHz

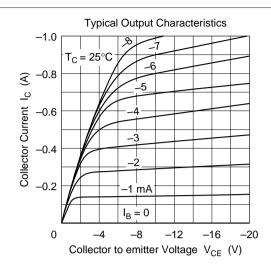
Notes: 1. The 2SB861 is grouped by  $h_{\text{FE1}}$  as follows.

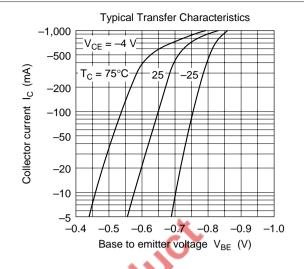
2. Pulse test

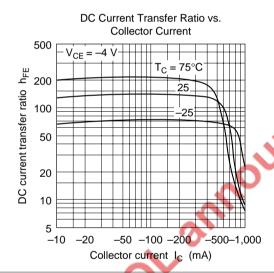
В	С
60 to 120	100 to 200

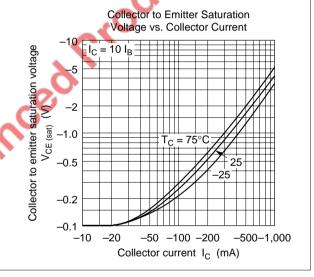












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